



SPEC NO.: SSR-109M

## **SPECIFICATION**

TO:STE516

Model Name: SAW RESONATOR

**PART NO: SSR3/4N**

CUSTOMER PART NO.:

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**STRONG ELECTRONICS&TECHNOLOGY LIMITED**

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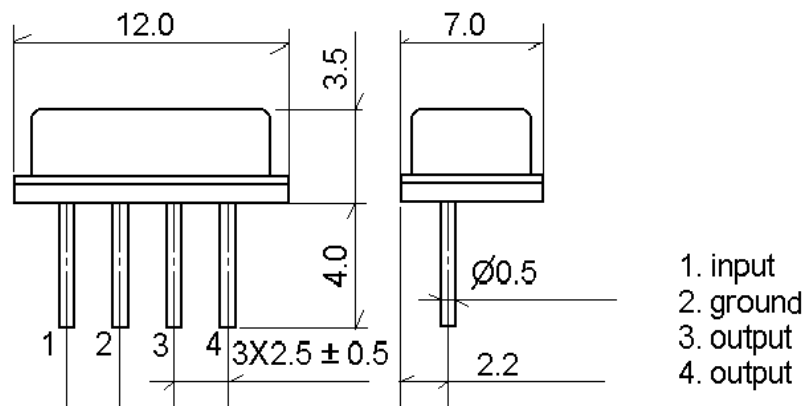
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**1. Package Dimension:**



**2. Marking**

SSR3/4N

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- (1) Ink Marking or Laser Marking
- (2) SSR: STRONG LOGO
- (3) 3/4N: Model code
- (4) • : Pin 1 Identifier
- (5) H6: Date code

H													6
Month code													Last figure of year
Month	1	2	3	4	5	6	7	8	9	10	11	12	
Month code	A	B	C	D	E	F	G	H	I	J	K	L	

e.g.: "H6" means August of 2006

**4. Performance**

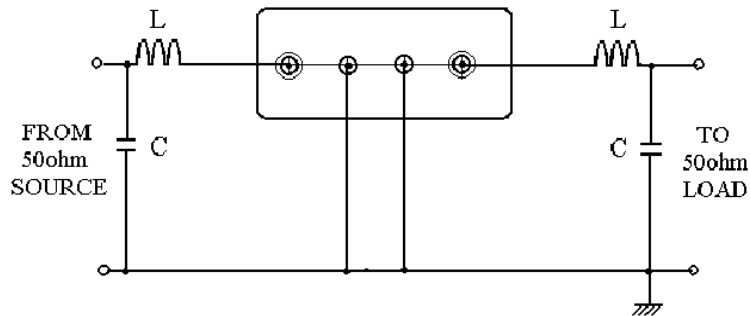
4.1 Maximum Rating

Item	Value
Operation Temperature Range	-40°C to +80°C
Storage Temperature Range	-45°C to +85°C
DC Voltage	10V
Source Power	0 dBm

4.2 Electronic Characteristics

Item	Unites	Minimum	Typical	Maximum
Resonant Frequency	MHz	61.16 67.16	61.24 67.24	61.32 67.32
Resonant Loss	dB		4.0	5.0
Parallel Capacitance	pF	3.4 3.2	4.4 4.2	5.4 5.2
Temp.Characteristics	ppm/°C	-8	0	+8

4.3 Test Circuit



5. Reliability

5.1 Resistance to Soldering heat:

5.1.1 The components shall remain within the electrical specifications after it soldered on the 1mm-thickness PCB board and dipped in the solder at  $260^{\circ}\text{C}\pm 5^{\circ}\text{C}$  for  $10\pm 1$  seconds.

5.1.2 The components shall remain within the electrical specifications after it soldered by electric iron, solder at  $350^{\circ}\text{C}\pm 10^{\circ}\text{C}$  for 3~4 seconds, recovery time :  $2\text{h}\pm 0.5\text{h}$ .

5.2 Thermal Shock:

The components shall remain within the electrical specifications after being kept at the condition of heat cycle conditions:  $T_A = -40^{\circ}\text{C}\pm 3^{\circ}\text{C}$ ,  $T_B = 85^{\circ}\text{C}\pm 2^{\circ}\text{C}$ ,  $t_1 = t_2 = 30\text{min}$ , switch time  $\leq 3\text{min}$  & cycle time : 100 times, recovery time :  $2\text{h}\pm 0.5\text{h}$ .

### 5.3 The Temperature Storage:

5.3.1 High Temperature Storage: The components shall remain within the electrical specifications after being kept at the  $85\pm 2$  for 500 hours, recovery time :  $2h\pm 0.5h$ .

5.3.2 Low Temperature Storage: The components shall remain within the electrical specifications after being kept at the  $-40\pm 3$  for 500 hours, recovery time :  $2h\pm 0.5h$ .

### 5.4 Humidity test:

The components shall remain within the electrical specifications after being kept at the condition of ambient temperature  $60\pm 2$ , and 90~95% RH for 500 hours.

### 5.5 Drop test:

The components shall remain within the electrical specifications after random free drops 10 times from height of 1.0 meter onto concrete floor, and the specimens shall meet the electrical specifications in table 5, external visual inspection.

### 5.6 Solder ability test:

at the condition of temperature  $245^{\circ}\text{C}\pm 5^{\circ}\text{C}$  Depth: DIP 2/3 , SMD 1/5, time: 3.0s-5.0s, 80% or more of the immersed surface shall be covered with solder and well-proportioned.

### 5.7 Vibration Fatigue:

The components shall remain within the electrical specifications after loaded vibration at 10~55Hz, amplitude 1.5mm, X, Y, Z, direction, for 2 hours.

### 5.8 Terminal strength:

The force  $10\pm 1$  seconds of 19.6N is applied to each terminal, and  $45^{\circ}$  in the same direction 2 times with 2N bending force (Exception: SMD)

### 5.9 Mechanical Shock:

The components shall remain within the electrical specifications after 1000 shocks, acceleration  $392\text{ m/s}^2$ , duration 6ms.

## 6. Remarks

### 6.1 Static voltage

Static voltage between signal load & ground may cause deterioration & destruction of the component. Please avoid static voltage.

### 6.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning.

### 6.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.